IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Todd O. Bolken

Serial No.: 10/791,192

Filed: March 2, 2004

For: TWO-STAGE TRANSFER MOLDING

DEVICE TO ENCAPSULATE MMC

MODULE

Confirmation No.: 1966

Examiner: D. Zarneke

Group Art Unit: 2891

Attorney Docket No.: 2269-4794.4US (01-0185.04/US)

Notice of Allowance Mailed:

May 1, 2007

VIA ELECTRONIC FILING July 25, 2007

AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)

Mail Stop ISSUE FEE Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

Amendments to the specification begin on page 3 of this paper;

A listing of the claims begins on page 7 of this paper;

Corrections to the drawings are summarized on page 10 of this paper, with replacement sheets and annotated sheets showing the corrections enclosed herewith; and

Remarks start at page 11 of this paper.